

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KAZUMA TAKENO	06/13/2018
MITSUTOSHI MAEDA	06/13/2018
HIROSHI TOKUTOMI	06/13/2018
TETSUYA SATO	06/13/2018
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<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16085065
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<b>SIGNATURE:</b>	/Benjamin J. Hauptman/
<b>DATE SIGNED:</b>	09/14/2018
<b>Total Attachments: 3</b>	
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ASSIGNMENT

For value received, we, Kazuma TAKENO; Mitsutoshi MAEDA; Hiroshi TOKUTOMI; and Tetsuya SATO having post office address at C/O MITSUBISHI HEAVY INDUSTRIES, LTD., 16-5, Konan 2-Chome, Minato-ku, Tokyo 1088215, Japan hereby sell, assign and transfer to MITSUBISHI HEAVY INDUSTRIES, LTD., a corporation existing under the laws of Japan located at 16-5, Konan 2-Chome, Minato-ku, Tokyo 1088215, Japan and its successors, assigns, and legal representatives the entire right, title, and interest for all countries including the United States of America, in and to certain inventions relating to METHOD FOR MANUFACTURING COMPOSITE MATERIAL described in application for Letters Patent of the United States, executed by me/us on this date, and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I/We have full right so to do, and agree that I/We will communicate to said Company or its representatives any facts known to me/us respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Signature Kazuma Takeno Date June 13, 2018  
Kazuma TAKENO

Signature \_\_\_\_\_ Date \_\_\_\_\_  
Mitsutoshi MAEDA

Signature Hiroshi Tokutomi Date June 13, 2018  
HIROSHI TOKUTOMI

Signature Tetsuya SATO Date June 13, 2018  
Tetsuya SATO

Signature \_\_\_\_\_ Date \_\_\_\_\_  
Kazuma TAKENO

Signature Mitsutoshi MAEDA Date June 13, 2018  
Mitsutoshi MAEDA

Signature \_\_\_\_\_ Date \_\_\_\_\_  
Hiroshi TOKUTOMI

Signature \_\_\_\_\_ Date \_\_\_\_\_  
Tetsuya SATO